

**Surface Mount General Purpose Silicon Rectifiers**
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**Reverse Voltage - 50 to 1000 V**
**Forward Current - 2 A**
**FEATURES**

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg 0.00086oz

**PINNING**

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View

Marking Code : S2A-S2M

Simplified outline SMAF and symbol

**Maximum Ratings and Electrical characteristics**

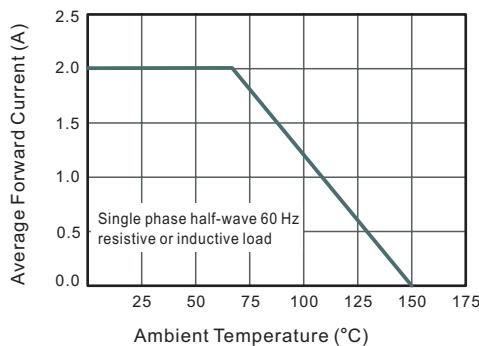
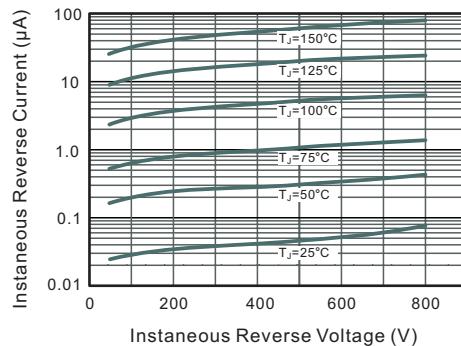
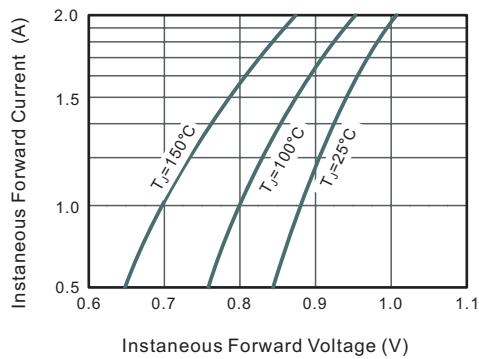
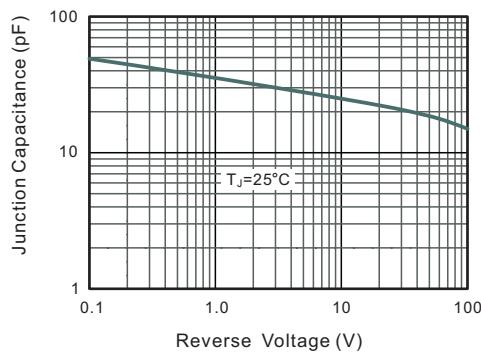
Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	S2AF	S2BF	S2DF	S2GF	S2JF	S2KF	S2MF	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at Ta = 65 °C	I <sub>F(AV)</sub>	2							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	60							A
Maximum Instantaneous Forward Voltage at 2 A	V <sub>F</sub>	1.1							V
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta = 125 °C	I <sub>R</sub>	5 50							µA
Typical Junction Capacitance <sup>1)</sup>	C <sub>j</sub>	30							pF
Typical Thermal Resistance <sup>2)</sup>	R <sub>θJA</sub>	50							°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150							°C

1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

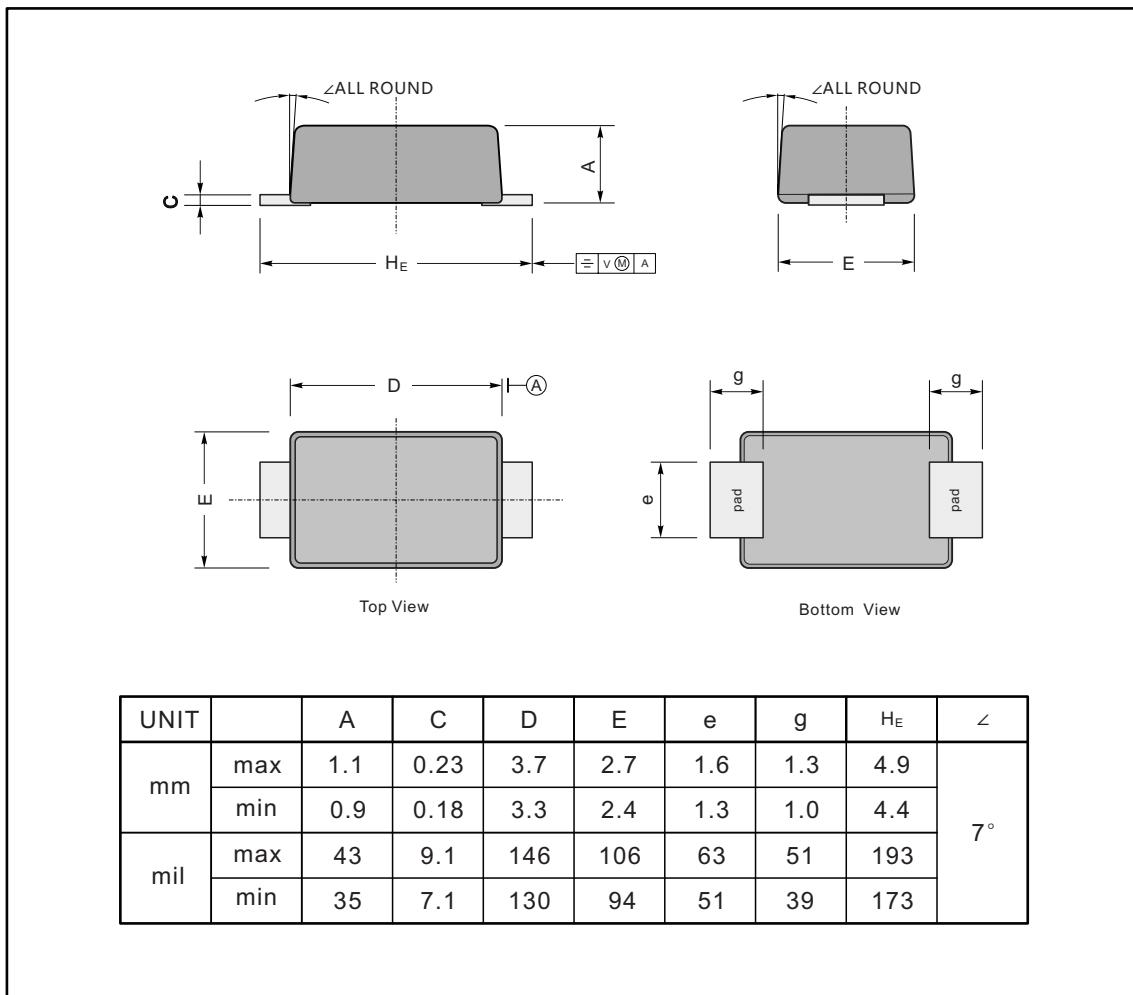
2 ) Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length, P.C.B. mounted

**Fig.1 Forward Current Derating Curve**

**Fig.2 Typical Instantaneous Reverse Characteristics**

**Fig.3 Typical Forward Characteristic**

**Fig.4 Typical Junction Capacitance**


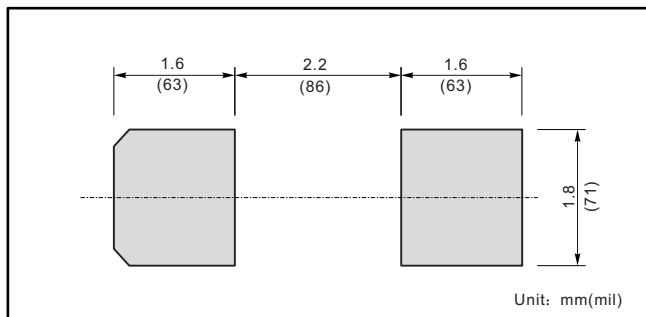
## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAF



**The recommended mounting pad size**  
**The recommended mounting pad size**



**Marking**

Type number	Marking code
S2AF	S2A
S2BF	S2B
S2DF	S2D
S2GF	S2G
S2JF	S2J
S2KF	S2K
S2MF	S2M